

Electronic Patent Application Fee Transmittal

Application Number:	10590046			
Filing Date:	15-Jun-2007			
Title of Invention:	Base Material for Pattern Forming Material, Positive Resist Composition and Method of Resist Pattern Formation			
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Filer:	Neil S. Bartfeld/Jennifer Dolan			
Attorney Docket Number:	SHIGA7.055APC			
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Submission- Information Disclosure Stmt	1806	1	180	180
Total in USD (\$)				180